DS3830 - 3.0

SP8715

1100MHz VERY LOW CURRENT MULTI-MODULUS DIVIDER

The SP8715 is a switchable divide by 64/65, 128/129 programmable divider which is guaranteed to operate up to 1100MHz. It will operate from a supply of 2.7V to 5.25V and requires typically 3.6mA (including the output current). It also features a power down facility for battery economy.

The RF inputs are internally biased and should be capacitively coupled to the signal source. The output is designed to interface with CMOS synthesisers.

FEATURES

- Operation to 1100MHz
- Very Low Power
- Single Supply Operation 2.7V to 5.25V
- Power Down Facility for Battery Economy
- Latched Modulus Control Input
- Push Pull Output Drive
- ESD Protection on All Pins†

APPLICATIONS

- Cellular Telephones
- Cordless Telephones
- Mobile Radio

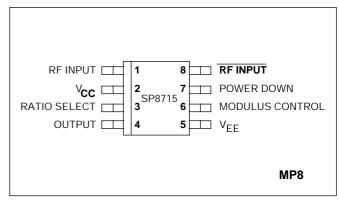


Fig. 1 Pin connections - top view

ORDERING INFORMATION

SP8715 IG MPAS Industrial Temperature Range

Miniature Plastic DIL Package

SP8715 IG MPAC As above supplied on Tape and Reel

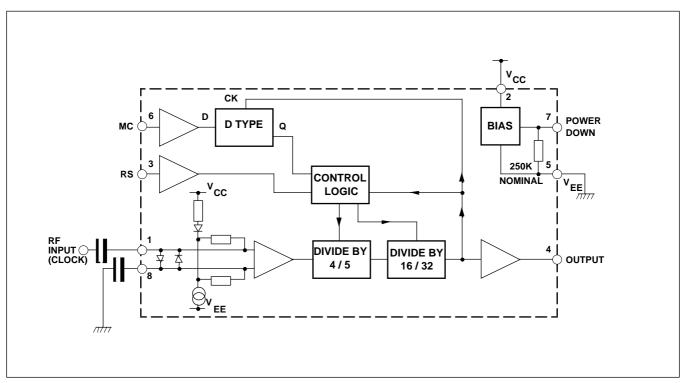


Fig. 2 Block diagram

[†] ESD precautions must be observed

SP8715

ABSOLUTE MAXIMUM RATINGS

Supply voltage (V_{EE}=0V) (note 1) -0.5V to 7V

Control and RF inputs,

RF output ($V_{EE} = 0V$) (note 1) -0.5V to $V_{CC} + 0.5V$ RF input current (note 1) 10mA

Operating temperature
Storage temperature range

Maximum junction temperature

-40°C to +85°C
-55°C to +150°C

+150°C

NOTE 1. Duration <2 minutes.

ELECTRICAL CHARACTERISTICS

Guaranteed over the following conditions (unless otherwise stated):

 V_{CC} =+2.7V to +5.25V (with respect to V_{EE}), Output load (pin 4) = 10pF, T_{amb} = -40°C to +85°C (note 2)

Characteristic		Value				
		Min.	Тур. Мах.	Units	Conditions	
Supply current	(note 3)		3.6	4.2	mA	Power down input low
Supply current	(note 3)		8	50	μΑ	Power down input high
Power down high		V _{CC} -0.5		V _{CC}	V	
Power down low		0		V _{CC} -2.0	V	
Modulus control high	(note 4)	0.6V _{CC}		V _{CC}	V	Divide by 64 or 128
Modulus control low	(note 4)	0		0.4V _{CC}	V	Divide by 65 or 129
Ratio select high	(note 4, 9)	0.6V _{CC}		V _{CC}	V	Divide by 64 or 65
Ratio select low	(note 4, 9)	0		0.4V _{CC}	V	Divide by 128 or 129
Max. sinewave input frequency		1100			MHz	See Figure 5
Min. sinewave input frequency				200	MHz	See Figure 5
Min. RF input voltage				50	mV RMS	RF input 200MHz to 1100MHz. See Figure 5
Max. RF input voltage		200			mV RMS	RF input 200MHz to 1100MHz. See Figure 5
Output level (pin 4)		500	600		mV p-p	
Modulus set-up time, t _s	(notes 5,6,8)	20			ns	RF input = 1GHz
Modulus hold time, t _h	(notes 6,8)			1	ns	RF input = 1GHz
Power down time, t _{pd}	(notes 7,8)			10	μs	See Figure 9
Power down recovery time, t _{pu} (notes 7,8)				6	μs	See Figure 9

NOTES

- 2. All electrical testing is performed at +85°C.
- 3. Typical values are measured at +25°C and V_{CC} = +5V.
- 4. Modulus Control and Ratio Select are high impedance inputs which can be driven directly by standard CMOS outputs.
- 5. Modulus control is latched at the end of the previous cycle.
- 6. See Figure 4.
- 7. See Figure 8.
- 8. These parameters are not tested but are guaranteee by design.
- 9. The ratio select pin is not intended to be switched dynamically.

OPERATING NOTES

The RF inputs are biased internally and are normally coupled to the signal source with suitable capaitors.

The output stage has a novel design and is intended to drive a CMOS synthesiser input. External pull-down resistors or circuits are not required. The SP8715 is not suitable for driving TTL or similar devices.

The device will operate down to DC frequencies for non-sinusoidal signals provided that the input slew rate is better than 100V/µs.

POWER DOWN (pin 7) is connected internally to a pull-down resistor. If the battery economy facility is not used, pin 7 should be either left unconnected or connected to V_{FF}.

Ratio Select (Pin 3)	Modulus Control (Pin 6)	Division Ratio
L	L	129
L	Н	128
H	L	65
Н	Н	64

Table 1 Truth table

TITLE: (SP8715 FIG.3)

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Fig. 3 Typical input characteristics

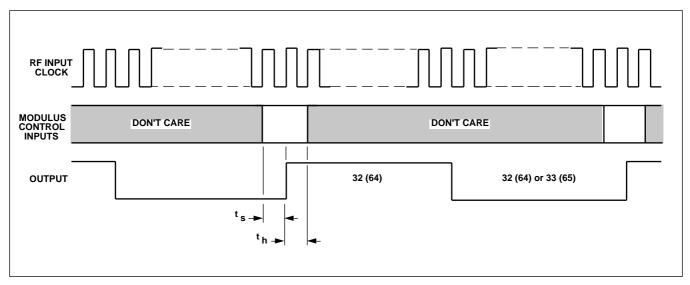


Fig. 4 Modulus control timing diagram

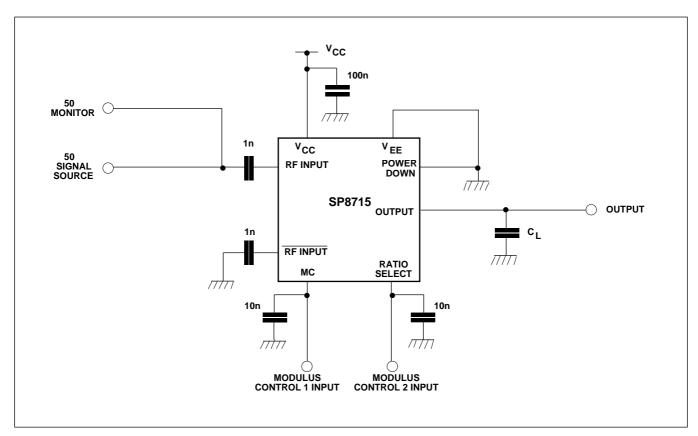


Fig. 5 Toggle frequency test circuit

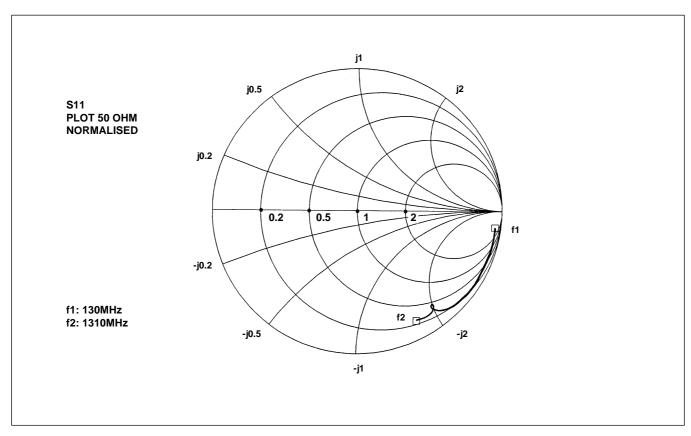


Fig. 6 Typical S11 parameter for pin 1. $V_{CC} = +5.0V$

TITLE: (SP8715 FIG.8) CREATOR: Adobe Illustrator(TM) 3.2 CR DATE: (20/5/93) (3:14 pm) R() jx()

Fig. 7 Typical input impedance v. frequency

FREQ-MHZ	R()	jx ()					
130.000	255.068	-733.538					
153.600	153.362	-688.623					
177.200	153.330	-583.339					
200.800	115.187	-545.839					
224.400	88.649	-482.377					
248.000	80.815	-441.798					
271.600	71.050	-411.502					
295.200	56.207	-369.645					
318.800	39.526	-346.620					
342.400	41.338	-323.129					
366.000	38.779	-304.804					
389.600	39.210	-280.556					
413.200	23.809	-269.674					
436.800	21.221	-255.279					
460.400	27.545	-245.161					
484.000	23.333	-234.680					
507.600	22.227	-224.572					
531.200	19.931	-211.375					
554.800	17.767	-203.241					
578.400	17.636	-194.613					
602.000	14.607	-186.545					
625.600	12.479	-182.049					
649.200	13.075	-174.839					
672.800	12.891	-168.320					
696.400	12.583	-160.468					
720.000	11.250	-156.267					
743.600	10.213	-149.642					
767.200	10.187	-145.328					
790.800	11.269	-143.144					
814.400	11.081	-137.557					
838.000	10.509	-132.750					
861.600 885.200	10.063 10.172	-129.254 -124.495					
908.800	10.772	-124.493 -120.568					
932.400	10.745	-120.308					
956.000	10.884	-113.395					
979.600	12.260	-109.552					
1003.20	12.984	-105.975					
1026.80	14.508	-103.110					
1050.40	16.625	-99.886					
1074.00	19.260	-98.149					
1097.60	22.799	-98.605					
1121.20	23.285	-99.907					
1144.80	21.149	-100.925					
1168.40	18.956	-99.639					
1192.00	16.434	-98.425					
1215.60	14.377	-95.033					
1239.20	13.743	-92.553					
1262.80	12.711	-89.249					
1286.40	12.776	-86.081					
1310.00	12.598	-82.581					

Table.2 Coefficients for Fig.7

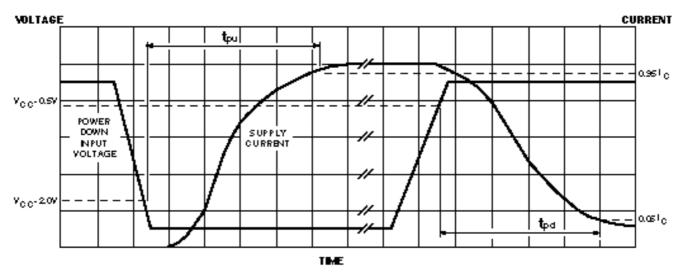


Fig. 8 Power up and power down

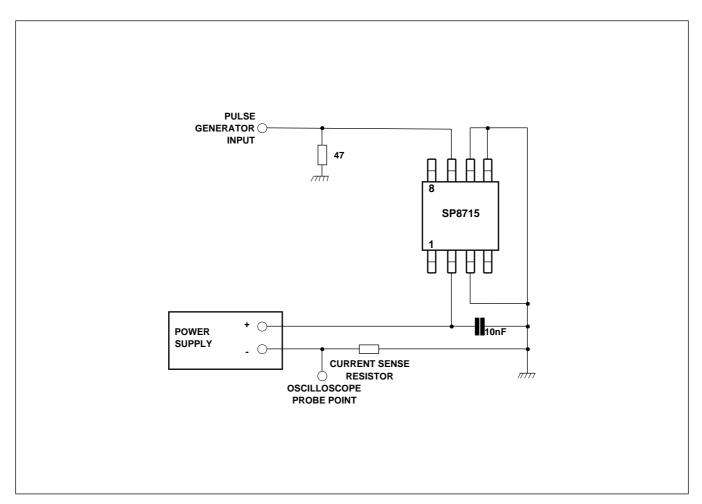
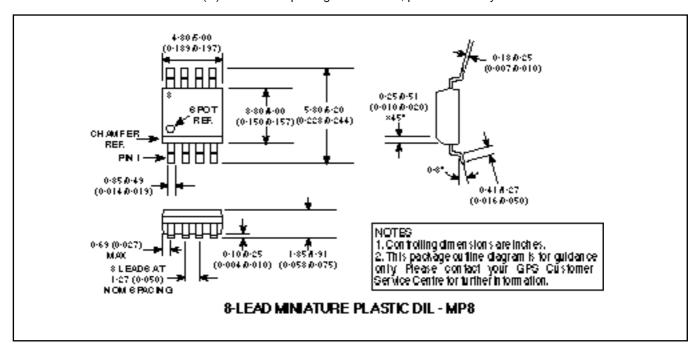


Fig. 9 Power-down time test circuit

SP8715

PACKAGE DETAILS

Dimensions are shown thus: mm (in). For further package information, please contact your local Customer Service Centre.





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